INSTALLATION INSTRUCTIONS - EFFISUS 2BOND GO TAPE
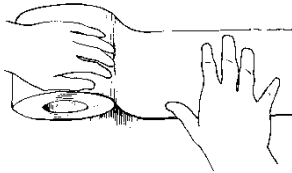
Substrate Preparation

1

All substrates should be dry. Please clean all non-absorptive, smooth substrates using the Effisus Setup PR Cleaner.

Bonding operations can not be carried out at temperatures below -5ºC or above +40ºC.
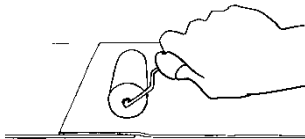
Connecting Operations

2

To apply the Effisus 2Bond GO Tape, remove one side of the release liner and apply to the surface to be protected or bonded. Rub or roll with pressure using your hand or a steel roller to activate bonding process. Remove the second release liner and apply second surface to tape, apply pressure.
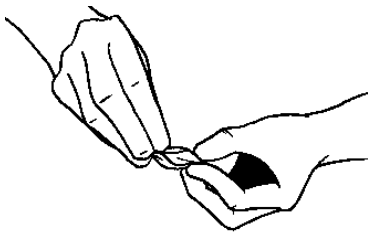
Overlaps

3

Seams between Effisus 2Bond GO Tapes should have a minimum overlap of 100mm.
Adhere the top Effisus 2Bond GO Tape over the bottom Effisus 2Bond GO Tape. Rub or roll with pressure using a steel roller to activate bonding process.

Putty

4

Effisus 2Bond GO Tape also can be used as a putty. Remove both release liners and roll into a rope. Place Effisus 2Bond GO over the gap and mold to the seal the opening.
Effisus 2Bond GO Tape is self-sealing. It can be used to seal penetrating screws or nail shanks.